



### DZ9F2V7S92 - DZ9F24S92

#### SURFACE MOUNT ZENER DIODE

#### **Features**

- Ultra-Small Surface Mount Package (1.0 x 0.6 x 0.37mm)
- Flat-Lead, Thermally-Efficient Package Design
- Exposed, Easily Visible Terminals, No X-ray Inspection of Solder Joints Required (As for DFN Packages)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SOD923 (0.2mm Lead Width)
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe.
  Solderable per MIL-STD-202, Method 208 (a)
- Weight: 0.001 grams (Approximate)

#### SOD923 (0.2mm Lead Width)



Top View

## Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
(Type Number)-7*	Standard	SOD923 (0.2mm Lead Width)	10,000/Tape & Reel

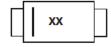
<sup>\*</sup>Add "-7" to the appropriate type number in Electrical Characteristics Table, example: 6.2V Zener = DZ9F6V2S92-7.

Notes

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

SOD923 (0.2mm Lead Width)



XX = Product Type Marking Code (See Electrical Characteristics Table)



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Forward Voltage	@ $I_F = 10mA$	V <sub>F</sub>	0.9	V	

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	Ь	200	mW	
Derate Above +25°C (Note 5)	PD	2.0	mW/°C	
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ heta JA}$	625	°C/W	
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C	

Note:

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

_		Zener Voltage Range (Note 6)			Maximum Zener Impedance (Note 7)		Temperature Coefficient		Total Capacitance	Maximum Reverse Current (Note 6)			
Type Number	Marking Codes		Vz @ Izt	-	I <sub>ZT</sub>	Z <sub>ZT</sub> @ I <sub>ZT</sub>	Z <sub>ZK</sub> @ I <sub>ZK</sub>	I <sub>ZK</sub>	Tc	@ I <sub>ZT</sub>	C <sub>T</sub> @ f = 1MHz, V <sub>R</sub> = 0V	I <sub>R</sub> @ V <sub>R</sub>	$V_R$
		Nom (V)	Min (V)	Max (V)	mA	2	Ω	mA	Min (mV/°C)	Max (mV/°C)	(pF)	μΑ	V
DZ9F2V7S92	ZB	2.7	2.57	2.84	5	100	1,000	1	-3.5	0	210	20	1
DZ9F3V0S92	ZC	3.0	2.85	3.15	5	100	1,000	1	-3.5	0	210	10	1
DZ9F3V3S92	ZD	3.3	3.14	3.47	5	100	1,000	1	-3.5	0	210	10	1
DZ9F3V6S92	ZE	3.6	3.42	3.78	5	100	1,000	1	-3.5	0	210	10	1
DZ9F3V9S92	ZF	3.9	3.71	4.10	5	100	1,000	1	-3.5	-2.5	210	5	1
DZ9F4V1S92	Z1	4.1	3.94	4.36	5	100	1,000	1	-3.5	0	210	5	1
DZ9F4V3S92	ZG	4.3	4.09	4.52	5	100	1,000	1	-3.5	0	210	5	1
DZ9F4V7S92	ZH	4.7	4.47	4.94	5	100	800	0.5	-3.5	0.2	150	2	1
DZ9F5V1S92	ZI	5.1	4.85	5.36	5	80	500	0.5	-2.7	1.2	130	2	1.5
DZ9F5V6S92	ZJ	5.6	5.32	5.88	5	60	200	0.5	-2.0	2.5	115	1	2.5
DZ9F6V2S92	ZK	6.2	5.89	6.51	5	60	100	0.5	0.4	3.7	110	1	3
DZ9F6V8S92	ZL	6.8	6.46	7.14	5	40	60	0.5	1.2	4.5	105	0.5	3.5
DZ9F7V5S92	ZM	7.5	7.13	7.88	5	30	60	0.5	2.5	5.3	100	0.5	4
DZ9F8V2S92	ZN	8.2	7.79	8.61	5	30	60	0.5	3.2	6.2	90	0.5	5
DZ9F9V1S92	ZO	9.1	8.65	9.56	5	30	60	0.5	3.8	7	80	0.5	6
DZ9F10S92	ZP	10	9.50	10.50	5	30	60	0.5	4.5	8	80	0.1	7
DZ9F11S92	ZQ	11	10.45	11.55	5	30	60	0.5	5.4	9	80	0.1	8
DZ9F12S92	ZR	12	11.40	12.60	5	30	80	0.5	6	10	80	0.1	9
DZ9F13S92	ZS	13	12.35	13.65	5	37	80	0.5	7	11	75	0.1	10
DZ9F15S92	ZT	15	14.25	15.75	5	42	80	0.5	9.2	13	70	0.1	11
DZ9F16S92	ZU	16	15.20	16.80	5	50	80	0.5	10.4	14	65	0.1	12
DZ9F18S92	ZV	18	17.10	18.90	5	50	80	0.5	12.4	16	60	0.1	14
DZ9F20S92	ZW	20	19.00	21.00	5	55	100	0.5	14.4	18	55	0.1	15.4
DZ9F22S92	ZX	22	20.90	23.10	5	55	100	0.5	15.4	20	55	0.1	16.8
DZ9F24S92	ZY	24	22.80	25.20	5	70	120	0.5	16.8	22	50	0.1	18.9

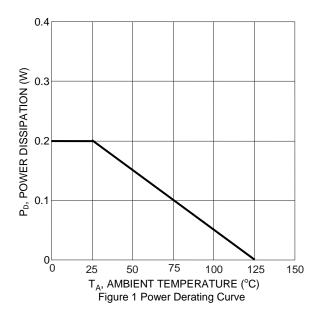
Notes:

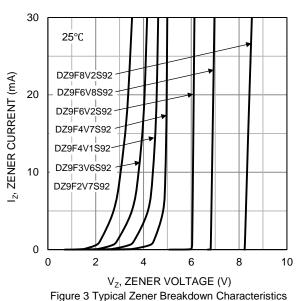
6. Short duration pulse test used to minimize self-heating effect.

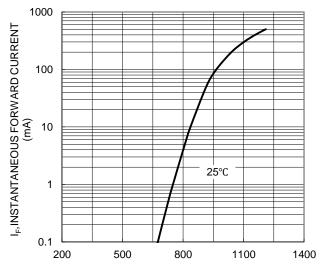
7. f = 1kHz.

<sup>5.</sup> Device mounted on FR-4 PCB with minimum recommended pad layout, as shown in Diodes Incorporated's Suggested Pad Layout document, which can be found on our website at http://www.diodes.com/package-outlines.html.









V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (mV) Figure 2 Typical Forward Characteristics

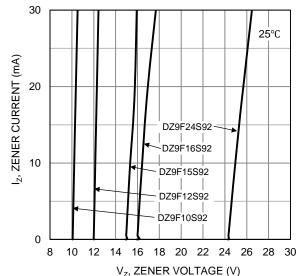


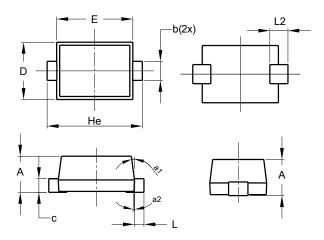
Figure 4 Typical Zener Breakdown Characteristics



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOD923 (0.2mm Lead Width)

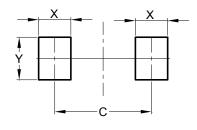


SOD923						
(0.	(0.2mm Lead Width)					
Dim	Min Max Typ					
Α	0.34	0.40	0.37			
b	0.15	0.25	0.20			
С	0.070	0.170	0.120			
D	0.55	0.65	0.60			
E	0.75	0.85	0.80			
Не	0.95	1.05	1.00			
L	0.05	0.15	0.10			
L2	0.190 REF					
a1	0°	8°	7°			
a2	2°	4°	3°			
All Dimensions in mm						

# **Suggested Pad Layout**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

### SOD923 (0.2mm Lead Width)



Dimensions	Value (in mm)		
С	0.900		
Х	0.300		
Y	0.400		



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